



General Description

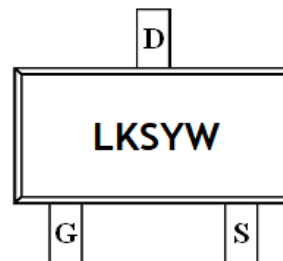
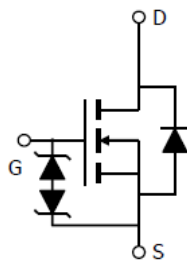
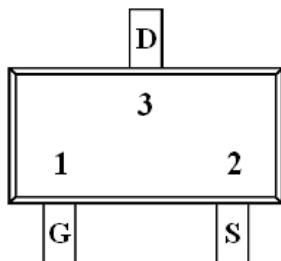
AFN1330LKS, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- 60V/0.50A , $R_{DS(ON)}=1.6\Omega@V_{GS}=10V$
- 60V/0.40A , $R_{DS(ON)}=2.5\Omega@V_{GS}=4.5V$
- 60V/0.05A , $R_{DS(ON)}=4.5\Omega@V_{GS}=2.5V$
- Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ESD Protection (>2KV) Diode design-in
- SOT-323 package design

Pin Description (SOT-323)



Application

- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- High saturation current capability. Direct Logic-Level Interface: TTL/CMOS
- Battery Operated Systems
- Solid-State Relays

Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN1330LKSS32RG	LKSYW	SOT-323	Tape & Reel	3000 EA

- ※ LKS Parts code
- ※ Y Year code (0 ~ 9)
- ※ W Week code (A ~ Z = 1 ~ 26 / a ~ z = 27 ~ 52)
- ※ AFN1330LKSS32RG : 7" Tape & Reel ; Pb- Free ; Halogen -Free



Absolute Maximum Ratings

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	60	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _D	T _A =25°C	0.5
		T _A =70°C	0.3
Pulsed Drain Current	I _{DM}	1.0	A
Continuous Source Current(Diode Conduction)	I _S	0.4	A
Power Dissipation	P _D	T _A =25°C	0.35
		T _A =70°C	0.22
Operating Junction Temperature	T _J	150	150
Storage Temperature Range	T _{STG}	-55/150	-55/150
Thermal Resistance-Junction to Ambient	R _{θJA}	120	120

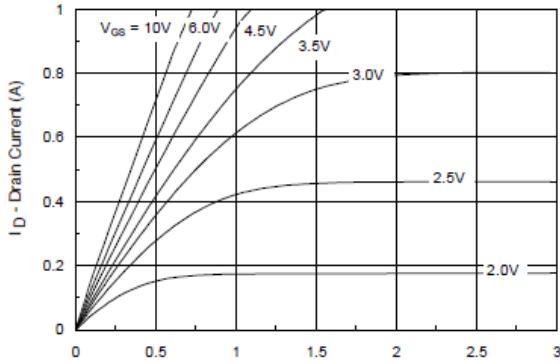
Electrical Characteristics

(T_A=25°C Unless otherwise noted)

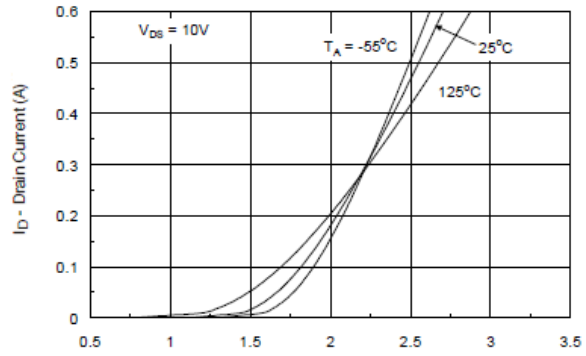
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	60			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	0.7	1.0	1.3	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			5	uA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =48V, V _{GS} =0V			1	uA
		V _{DS} =48V, V _{GS} =0V T _J =85°C			10	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =0.50A		0.95	1.6	Ω
		V _{GS} = 4.5V, I _D =0.40A		1.25	2.5	
		V _{GS} = 2.5V, I _D =0.05A		2.65	4.5	
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =0.2A		0.2		S
Diode Forward Voltage	V _{SD}	I _S =0.2A, V _{GS} =0V		0.82	1.4	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =30V, V _{GS} =10V I _D ≅0.25A		1.5	2.5	pC
Gate-Source Charge	Q _{gs}			0.2		
Gate-Drain Charge	Q _{gd}			0.5		
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V f=1MHz		28		pF
Output Capacitance	C _{oss}			10		
Reverse Transfer Capacitance	C _{rss}			5		
Turn-On Time	t _{d(on)}	V _{DD} =30V, R _G =6Ω I _D ≅0.25A, V _{GEN} =10V		3	7	ns
	t _r			12	30	
Turn-Off Time	t _{d(off)}			18	40	
	t _f			8	15	



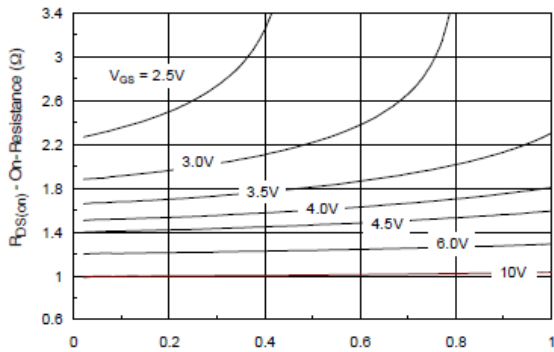
Typical Characteristics



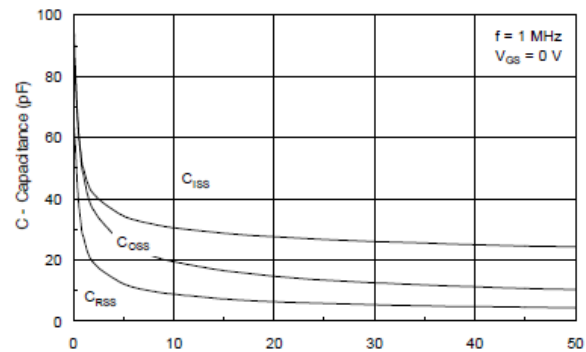
Output Characteristics



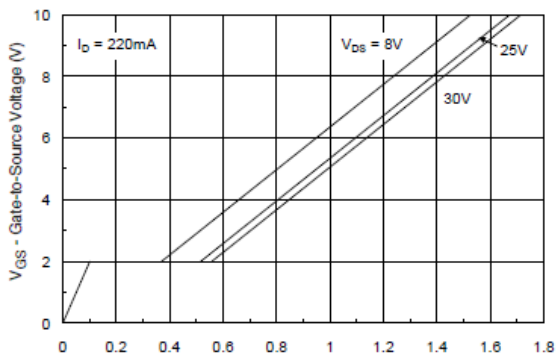
Transfer Characteristics



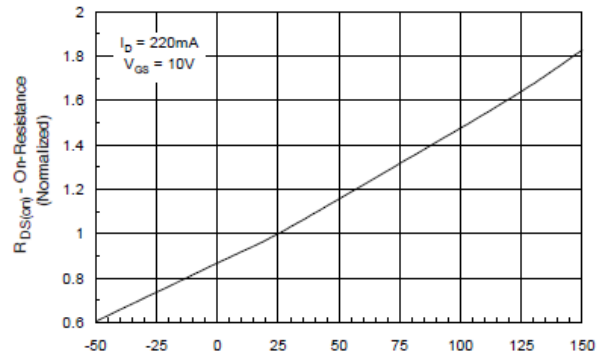
On-Resistance vs. Drain Current



Capacitance



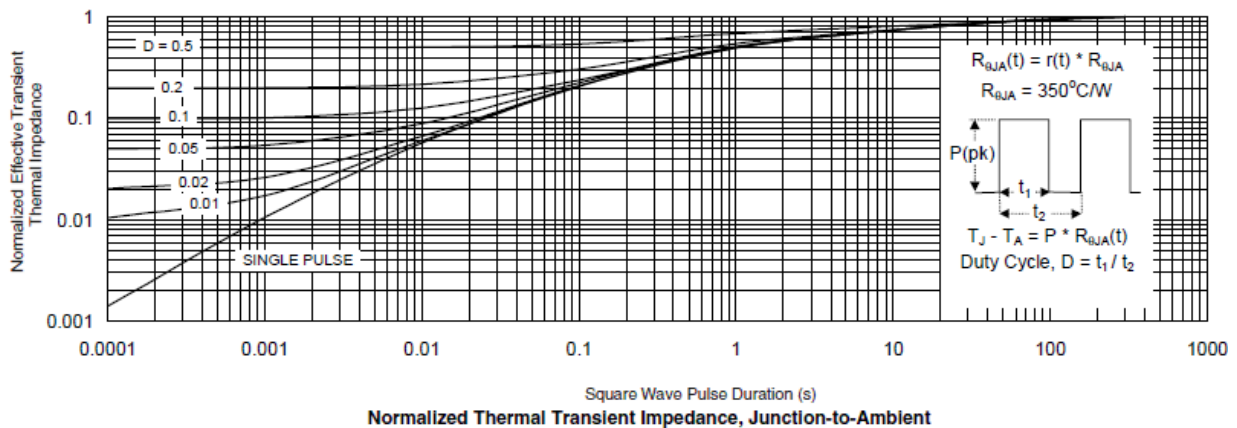
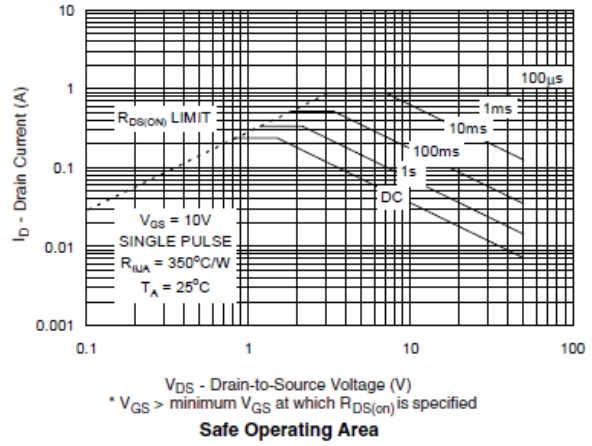
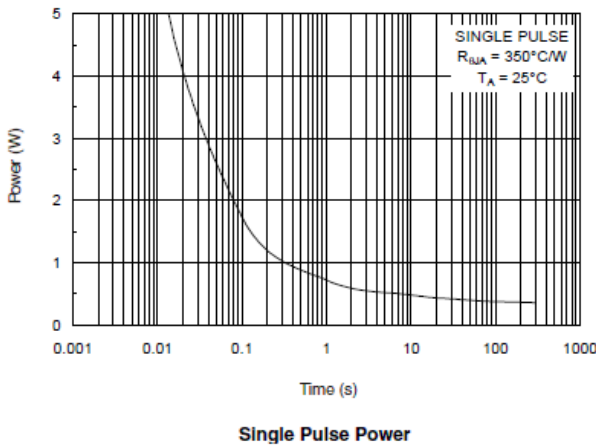
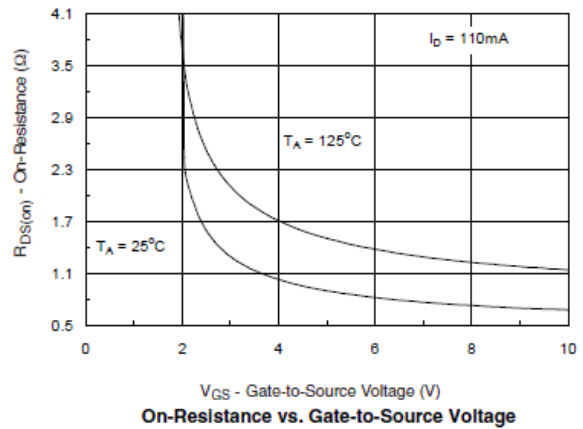
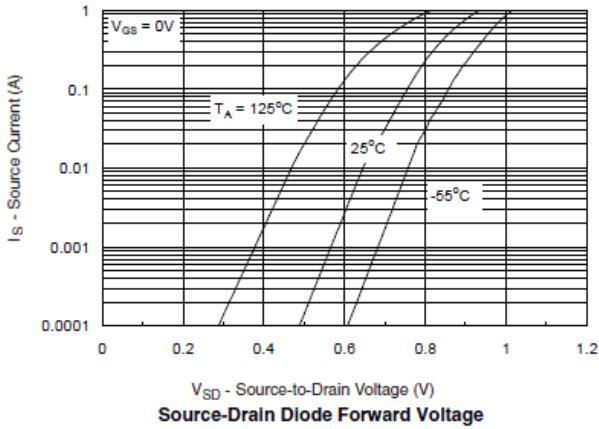
Gate Charge



On-Resistance vs. Junction Temperature



Typical Characteristics



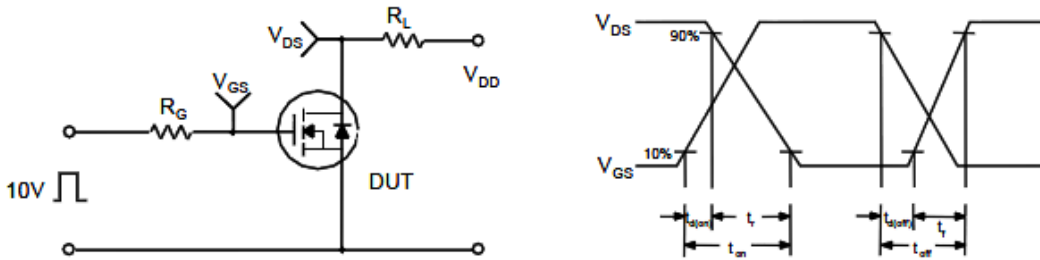


Typical Characteristics

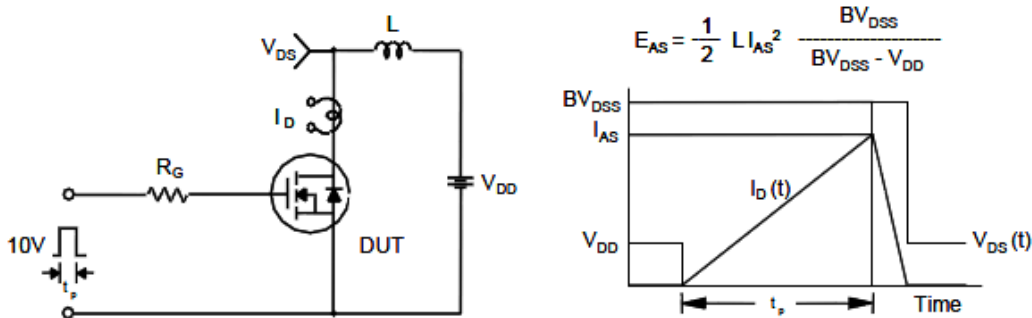
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

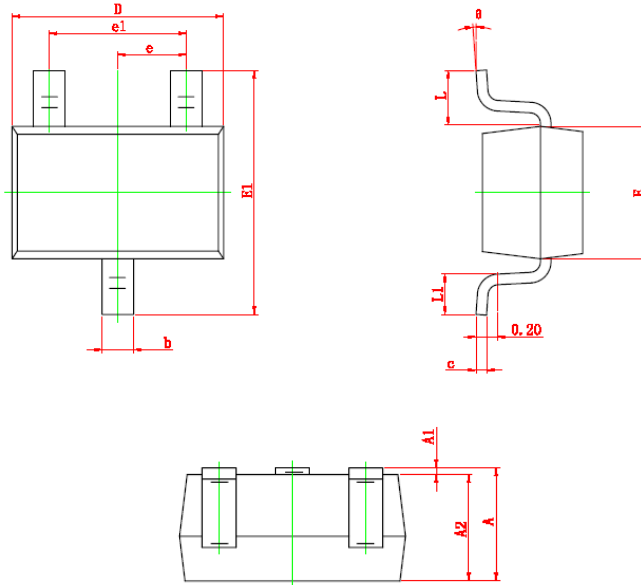


Unclamped Inductive Switching Test Circuit & Waveforms





Package Information (SOT-323)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°

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